010130719 \*\*Image available\*\*
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Mould for products with holographic images - has recess for holding a

removable engraved matrix plate

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Number of Countries: 001 Number of Patents: 002

Patent Family:

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Abstract (Basic): ES 2062915 A

The mould for injection or blow-moulding consists of one or more cavities of desired shape, contg. in at least one zone, a socket or groove for a removable matrix plate made from a holographic film. The product consists of a solid or hollow mass with an ultra-fine interference pattern engraved on at least one external surface, giving a three-dimensional view of an image.

Dwg.0/2

Title Terms: MOULD; PRODUCT; HOLOGRAM; IMAGE; RECESS; HOLD; REMOVE;

ENGRAVING; MATRIX; PLATE

Derwent Class: A32; A89; G06; P78; P84

International Patent Class (Main): A23G-003/18; B29C-039/34

International Patent Class (Additional): A23G-003/28; B29C-033/30;

B44C-001/24; G03H-001/02

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